

MMBT2222A

SMALL SIGNAL NPN TRANSISTOR

PRELIMINARY DATA

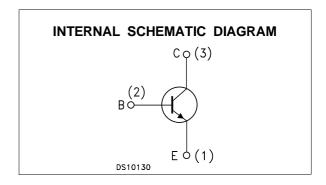
Туре	Marking
MMBT2222A	M22

- SILICON EPITAXIAL PLANAR NPN TRANSISTOR
- MINIATURE SOT-23 PLASTIC PACKAGE FOR SURFACE MOUNTING CIRCUITS
- TAPE & REEL PACKING
- THE PNP COMPLEMENTARY TYPE IS MMBT2907A

APPLICATIONS

- WELL SUITABLE FOR PORTABLE EQUIPMENT
- SMALL LOAD SWITCH TRANSISTOR WITH HIGH GAIN AND LOW SATURATION VOLTAGE





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Emitter Voltage (I _E = 0)	75	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	40	V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	6	V
Ic	Collector Current	0.6	Α
Ісм	Collector Peak Current (t _p < 5 ms)	0.8	Α
P _{tot}	Total Dissipation at T _{amb} = 25 °C	350	mW
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

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THERMAL DATA

R _{thj-amb} •	Thermal Resistance Junction-Ambient	Max	357.1	°C/W	
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[•] Device mounted on a PCB area of 1 cm².

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{CEX}	Collector Cut-off Current (V _{BE} = -3 V)	V _{CE} = 60 V			10	nA
I _{BEX}	Base Cut-off Current (V _{BE} = -3 V)	V _{CE} = 60 V			20	nA
Ісво	Collector Cut-off Current (I _E = 0)	$V_{CB} = 75 \text{ V}$ $V_{CB} = 75 \text{ V}$ $T_j = 150 ^{\circ}\text{C}$			10 10	nΑ μΑ
I _{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = 3 V			15	nA
V _{(BR)CEO*}	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = 10 mA	40			V
V _(BR) CBO	Collector-Base Breakdown Voltage (I _E = 0)	Ic = 10 μA	75			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	IE = 10 μA	6			V
V _{CE(sat)*}	Collector-Emitter Saturation Voltage	$I_{C} = 150 \text{ mA}$ $I_{B} = 15 \text{ mA}$ $I_{C} = 500 \text{ mA}$ $I_{B} = 50 \text{ mA}$			0.3 1	V V
V _{BE(sat)*}	Collector-Base Saturation Voltage	$I_C = 150 \text{ mA}$ $I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA}$ $I_B = 50 \text{ mA}$	0.6		1.2 2	V
hfe*	DC Current Gain	Ic = 0.1 mA	35 50 75 100 50 40		300	
f _T	Transition Frequency	$I_C = 20 \text{ mA } V_{CE} = 20 \text{V } f = 100 \text{MHz}$		270		MHz
Ссво	Collector-Base Capacitance	I _E = 0 V _{CB} = 10 V f = 1 MHz		4	8	pF
Сево	Emitter-Base Capacitance	$I_C = 0$ $V_{EB} = 0.5$ V $f = 1$ MHz		20	25	pF
NF	Noise Figure			4		dB
h _{ie} *	Input Impedance	$V_{CE} = 10 \text{ V}$ $I_{C} = 1 \text{ mA}$ $f = 1 \text{ KHz}$ $V_{CE} = 10 \text{ V}$ $I_{C} = 10 \text{ mA}$ $f = 1 \text{ KHz}$	2 0.25		8 1.25	ΚΩ ΚΩ
h _{re} *	Reverse Voltage Ratio	V _{CE} = 10 V I _C = 1 mA f = 1 KHz V _{CE} = 10 V I _C = 10 mA f = 1 KHz			8 4	10 ⁻⁴ 10 ⁻⁴
h _{fe} *	Small Signal Current Gain	$V_{CE} = 10 \text{ V}$ $I_{C} = 1 \text{ mA}$ $f = 1 \text{ KHz}$ $V_{CE} = 10 \text{ V}$ $I_{C} = 10 \text{ mA}$ $f = 1 \text{ KHz}$	50 75		300 375	
h _{oe} *	Output Admittance	$V_{CE} = 10 \text{ V}$ $I_{C} = 1 \text{ mA}$ $f = 1 \text{ KHz}$ $V_{CE} = 10 \text{ V}$ $I_{C} = 10 \text{ mA}$ $f = 1 \text{ KHz}$	5 25		35 200	μS μS

^{*} Pulsed: Pulse duration = 300 μs, duty cycle ≤ 2 %

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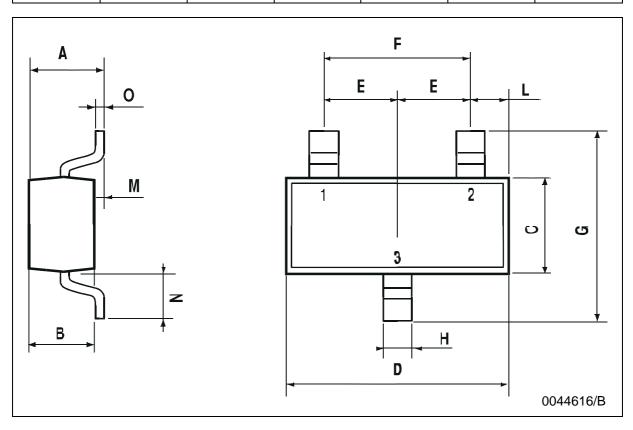
ELECTRICAL CHARACTERISTICS (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t_d	Delay Time	$I_C = 150 \text{ mA}$ $I_B = 15 \text{ mA}$		5	10	ns
tr	Rise Time	Vcc = 30 V		12	25	ns
ts	Storage Time	I _C = 150 mA I _{B1} = - I _{B2} = 15 mA		185	225	ns
t _f	Fall Time	$V_{CC} = 30 \text{ V}$		24	60	ns

^{*} Pulsed: Pulse duration = 300 μs, duty cycle ≤ 2 %

SOT-23 MECHANICAL DATA

DIM.		mm		mils		
Dim.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	0.85		1.1	33.4		43.3
В	0.65		0.95	25.6		37.4
С	1.20		1.4	47.2		55.1
D	2.80		3	110.2		118
E	0.95		1.05	37.4		41.3
F	1.9		2.05	74.8		80.7
G	2.1		2.5	82.6		98.4
Н	0.38		0.48	14.9		18.8
L	0.3		0.6	11.8		23.6
M	0		0.1	0		3.9
N	0.3		0.65	11.8		25.6
0	0.09		0.17	3.5		6.7



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